

applying the liquid material to the substrate at ambient temperature; wherein the application occurs in a manner which produces a tight, well-defined application pattern, the material curing substantially simultaneously upon application and adhering to the substrate in a manner which attenuates vibration, noise and harshness transmitted through the substrate.

2. (Amended) The method as defined in claim 1 wherein the ambient temperature ranges between about 35°F (1.7°C) and about 160°F (71.1°C).

3. (Amended) The method as defined in claim 2 wherein the ambient temperature ranges between about 50°F (10°C) and about 120°F (48.9°C).

4. (Amended) The method as defined in claim 1 wherein the substrate is applied at an ambient pressure ranging between about 730 mm Hg and about 800 mm Hg.

5. (Amended) The method as defined in claim 4 wherein the substrate is applied at an ambient pressure ranging between about 750 mm Hg and about 780 mm Hg.

Please delete claim 12 without prejudice.

13. (Amended) A method for damping vibration of a substrate comprising the steps of:
providing a substrate;
mixing at least two components to form a liquid material, wherein the first component consists essentially of at least one polyoxylene polymer present in an amount sufficient to impart a predetermined amount of tensile strength, hardness and flexibility, and the second component consists essentially of at least one isocyanate compound, the first and second components reacting upon mixing to form a polyurea; and

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applying the liquid material to the substrate at ambient temperature; wherein the application occurs in a manner which produces a tight, well-defined application pattern, the cured material adhering to the substrate in a manner which attenuates vibration, noise and harshness transmitted through the substrate.

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20. (Amended) A method for damping vibration of a substrate comprising the steps of:

providing a substrate;

mixing at least two components to form a liquid material, the first and second components reacting upon mixing;

wherein the first component consists essentially of at least one amine terminated polyoxylene polymer present in an amount sufficient to impart a predetermined amount of tensile strength, hardness and flexibility, and the second component consists essentially of at least one isocyanate compound having at least one-NCO radical reactive with the first component to form a polyurea compound; and

applying the liquid material to the substrate at ambient temperature, the liquid material cures substantially instantaneously;

wherein the application occurs in a manner which produces a tight, well-defined application pattern, the cured material adhering to the substrate in a manner which attenuates vibration, noise and harshness transmitted through the substrate.

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24. (Amended) A method for damping vibration of a substrate, the substrate being at least one of a metal stamping, a body in white, carbon graphite composites, fiberglass, polycarbonates, ABS, and structural polymeric materials, the method comprising the step of:

applying substantially organic a liquid material by at least one of spraying, dipping and brushing onto the substrate in an ambient environment, the ambient environment having a temperature ranging between about 35°F (1.7°C) and

about 160°F (71.1°C), wherein, after application to the substrate, the material cures in an interval ranging between about 15 seconds and about 20 seconds;

wherein the substantially organic liquid material consists essentially of:

a first component, consisting essentially of at least one polymer present in an amount sufficient to impart a predetermined amount of tensile strength, hardness and flexibility; and

a second component, consisting essentially of at least one isocyanate compound and is reactive with the first component;

wherein the application occurs in a manner which produces a tight, well-defined application pattern, the cured material adhering to the substrate in a manner which attenuates vibration, noise and harshness transmitted through the substrate.

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